查询"MMBT2369LT1G"供应商

MMBT2369LT1, MMBT2369ALT1

MMBT2369ALT1 is a Preferred Device

Switching Transistors

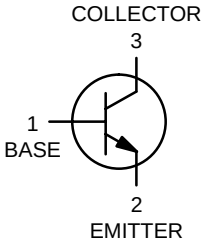
NPN Silicon

ON Semiconductor®

http://onsemi.com

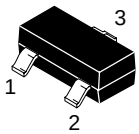
Features

- Pb−Free Packages are Available



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector−Emitter Voltage	V_{CEO}	15	Vdc
Collector−Emitter Voltage	V_{CES}	40	Vdc
Collector−Base Voltage	V_{CBO}	40	Vdc
Emitter−Base Voltage	V_{EBO}	4.5	Vdc
Collector Current − Continuous	I_C	200	mAdc



SOT−23
CASE 318
STYLE 6

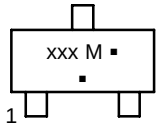
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR−5 Board (Note 1) T_A = 25°C Derate above 25°C	P_D	225 1.8	mW mW/°C
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T_A = 25°C Derate above 25°C	P_D	300 2.4	mW mW/°C
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T_J, T_{stg}	−55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR−5 = 1.0 × 0.75 × 0.062 in.
2. Alumina = 0.4 × 0.3 × 0.024 in. 99.5% alumina.

MARKING DIAGRAMS



xxx = M1J or 1JA
M = Date Code*
▪ = Pb−Free Package
(Note: Microdot may be in either location)
*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping
MMBT2369LT1	SOT−23	3000/Tape & Reel
MMBT2369LT1G	SOT−23 (Pb−Free)	3000/Tape & Reel
MMBT2369ALT1	SOT−23	3000/Tape & Reel
MMBT2369ALT1G	SOT−23 (Pb−Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

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January, 2007 − Rev. 5
Publication Order Number:
MMBT2369LT1/D

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Collector−Emitter Breakdown Voltage (Note 3) (I_C = 10 mAdc, I_B = 0)		$V_{(BR)CEO}$	15	–	–	Vdc
Collector−Emitter Breakdown Voltage (I_C = 10 μAdc, V_{BE} = 0)		$V_{(BR)CES}$	40	–	–	Vdc
Collector−Base Breakdown Voltage (I_C = 10 μAdc, I_E = 0)		$V_{(BR)CBO}$	40	–	–	Vdc
Emitter−Base Breakdown Voltage (I_E = 10 μAdc, I_C = 0)		$V_{(BR)EBO}$	4.5	–	–	Vdc
Collector Cutoff Current (V_{CB} = 20 Vdc, I_E = 0) (V_{CB} = 20 Vdc, I_E = 0, T_A = 150°C)		I_{CBO}	– –	– –	0.4 30	μAdc
Collector Cutoff Current (V_{CE} = 20 Vdc, V_{BE} = 0)	MMBT2369A	I_{CES}	–	–	0.4	μAdc
ON CHARACTERISTICS						
DC Current Gain (Note 3) (I_C = 10 mAdc, V_{CE} = 1.0 Vdc) (I_C = 10 mAdc, V_{CE} = 1.0 Vdc) (I_C = 10 mAdc, V_{CE} = 0.35 Vdc) (I_C = 10 mAdc, V_{CE} = 0.35 Vdc, T_A = −55°C) (I_C = 30 mAdc, V_{CE} = 0.4 Vdc) (I_C = 100 mAdc, V_{CE} = 2.0 Vdc) (I_C = 100 mAdc, V_{CE} = 1.0 Vdc)	 MMBT2369 MMBT2369A MMBT2369A MMBT2369A MMBT2369A MMBT2369 MMBT2369A	h_{FE}	 40 – 40 20 30 20 20	 – – – – – – – –	 120 120 – – – – – –	–
Collector−Emitter Saturation Voltage (Note 3) (I_C = 10 mAdc, I_B = 1.0 mAdc) (I_C = 10 mAdc, I_B = 1.0 mAdc) (I_C = 10 mAdc, I_B = 1.0 mAdc, T_A = +125°C) (I_C = 30 mAdc, I_B = 3.0 mAdc) (I_C = 100 mAdc, I_B = 10 mAdc)	 MMBT2369 MMBT2369A MMBT2369A MMBT2369A MMBT2369A	$V_{CE(sat)}$	 – – – – –	 – – – – –	 0.25 0.20 0.30 0.25 0.50	Vdc
Base−Emitter Saturation Voltage (Note 3) (I_C = 10 mAdc, I_B = 1.0 mAdc) (I_C = 10 mAdc, I_B = 1.0 mAdc, T_A = −55°C) (I_C = 30 mAdc, I_B = 3.0 mAdc) (I_C = 100 mAdc, I_B = 10 mAdc)	 MMBT2369A MMBT2369A MMBT2369A MMBT2369A	$V_{BE(sat)}$	 0.7 – – –	 – – – –	 0.85 1.02 1.15 1.60	Vdc
SMALL−SIGNAL CHARACTERISTICS						
Output Capacitance (V_{CB} = 5.0 Vdc, I_E = 0, f = 1.0 MHz)		C_{obo}	–	–	4.0	pF
Small Signal Current Gain (I_C = 10 mAdc, V_{CE} = 10 Vdc, f = 100 MHz)		h_{fe}	5.0	–	–	–
SWITCHING CHARACTERISTICS						
Storage Time (I_{B1} = I_{B2} = I_C = 10 mAdc)		t_s	–	5.0	13	ns
Turn−On Time (V_{CC} = 3.0 Vdc, I_C = 10 mAdc, I_{B1} = 3.0 mAdc)		t_{on}	–	8.0	12	ns
Turn−Off Time (V_{CC} = 3.0 Vdc, I_C = 10 mAdc, I_{B1} = 3.0 mAdc, I_{B2} = 1.5 mAdc)		t_{off}	–	10	18	ns

3. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

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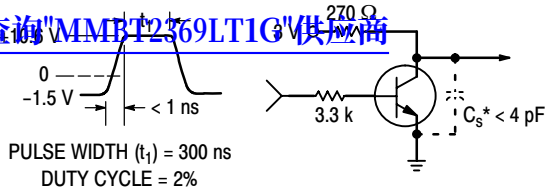

Figure 1. t_{on} Circuit − 10 mA

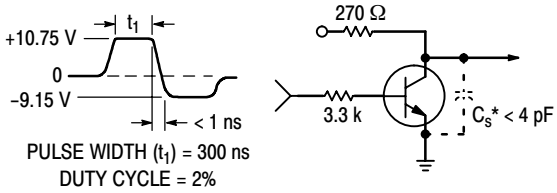

Figure 2. t_{off} Circuit − 10 mA

*Total shunt capacitance of test jig and connectors.

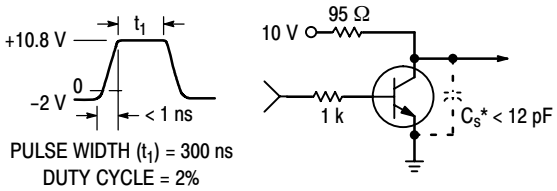

Figure 3. t_{on} Circuit − 100 mA

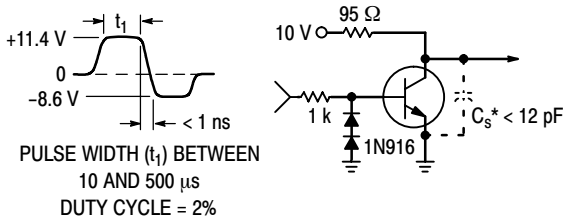

Figure 4. t_{off} Circuit − 100 mA

*Total shunt capacitance of test jig and connectors.

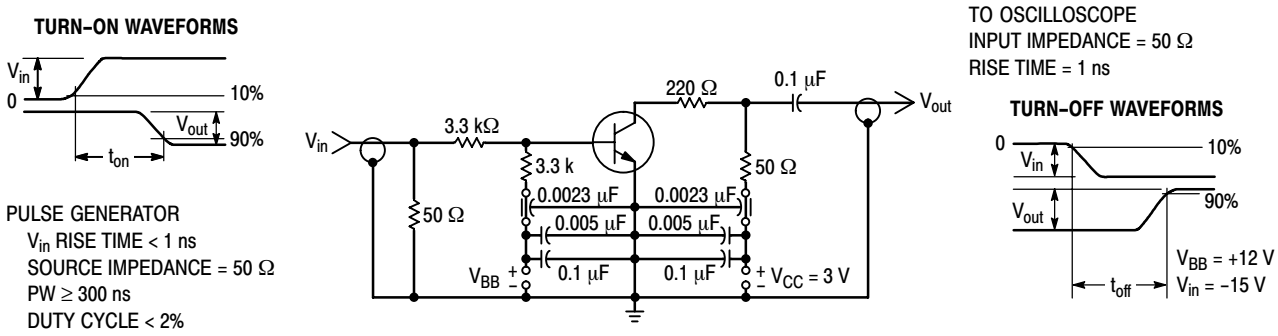

Figure 5. Turn−On and Turn−Off Time Test Circuit

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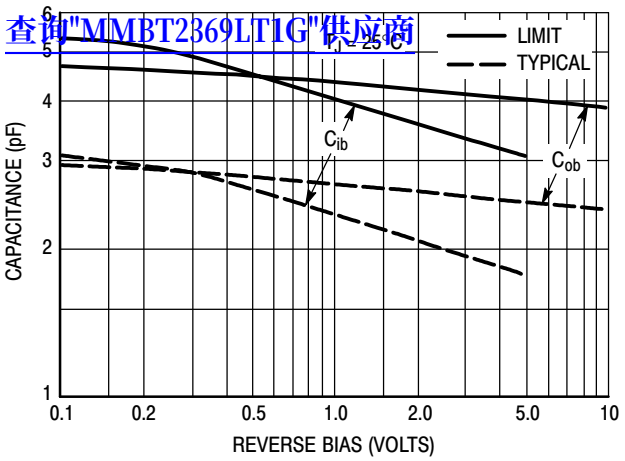

Figure 6. Junction Capacitance Variations

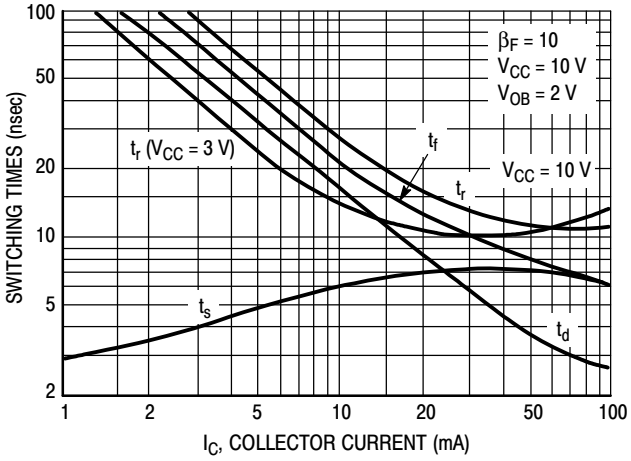

Figure 7. Typical Switching Times

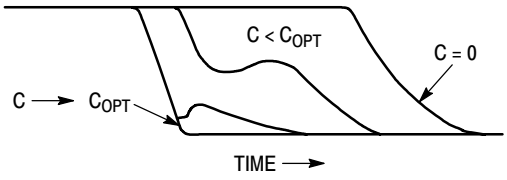

Figure 8. Turn−Off Waveform

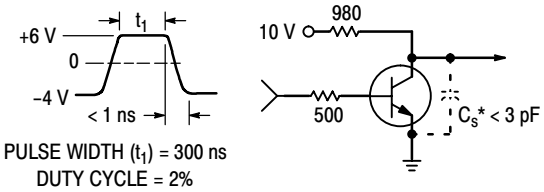

Figure 9. Storage Time Equivalent Test Circuit

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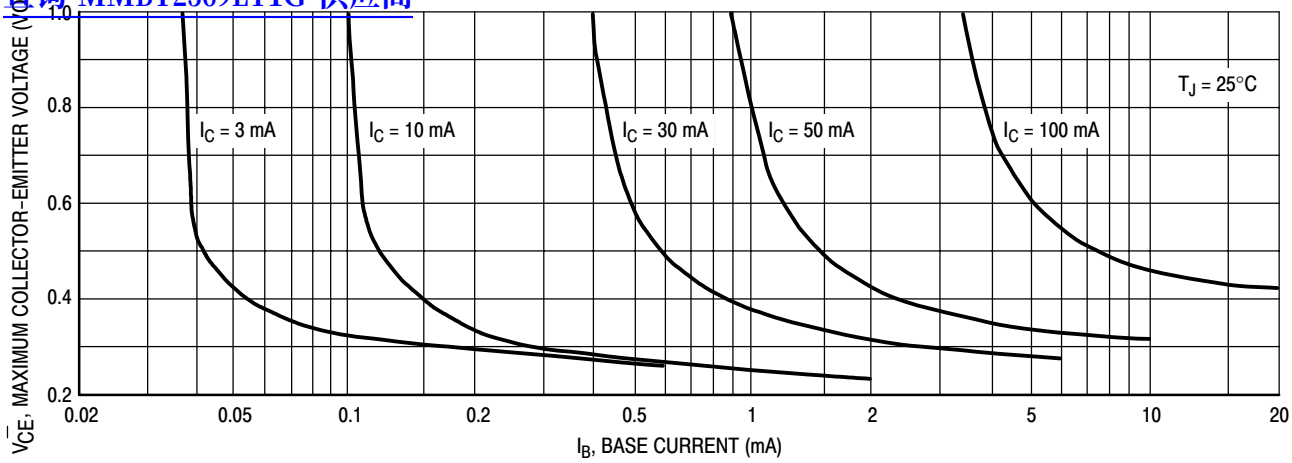

Figure 10. Maximum Collector Saturation Voltage Characteristics

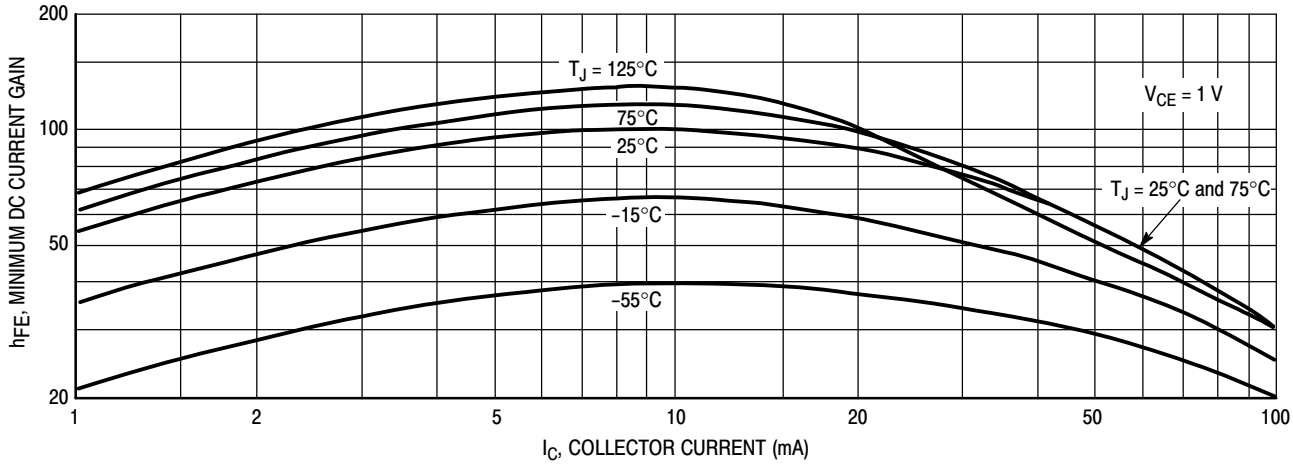

Figure 11. Minimum Current Gain Characteristics

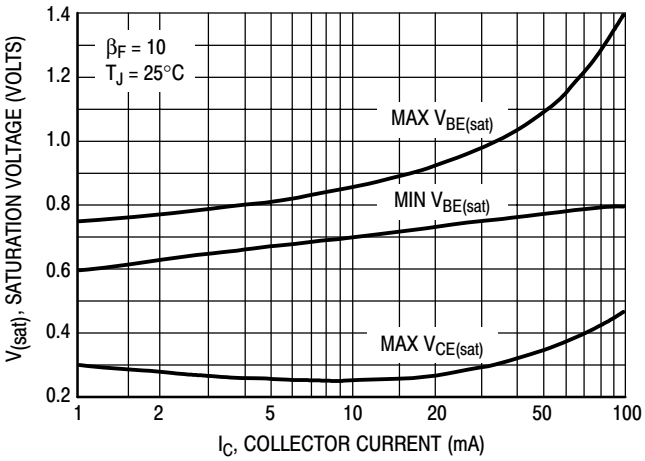

Figure 12. Saturation Voltage Limits

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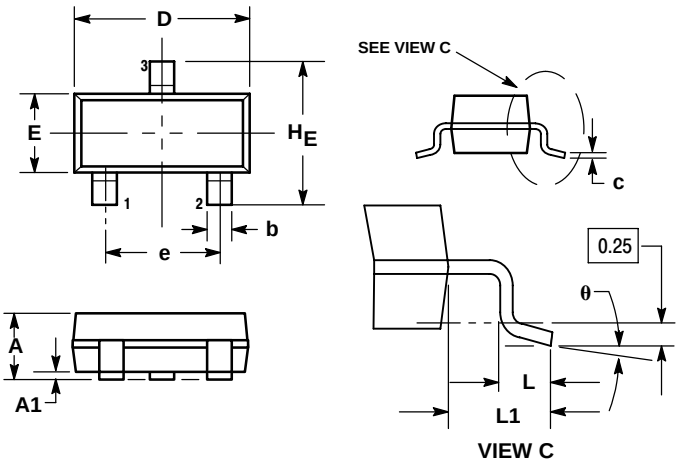
PACKAGE DIMENSIONS

SOT−23 (TO−236)
CASE 318−08
ISSUE AN

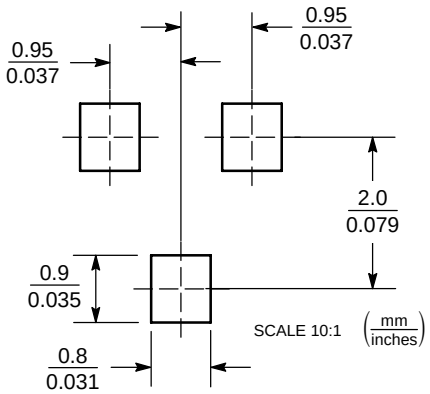


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318−01 THRU −07 AND −09 OBSOLETE, NEW STANDARD 318−08.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
H_E	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 6:
PIN 1. BASE
2. EMITTER
3. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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